

**HAOPIN MICROELECTRONICS CO.,LTD.**
**Description**

Standard gate triggering SCR is fully isolated package suitable for the application where requiring high bidirectional blocking voltage capability and also suitable for over voltage protection ,motor control circuit in power tool, inrush current limit circuit and heating control system.

Symbol		Simplified outline
		 TO-220
Pin	Description	
1	Cathode	
2	Anode	
3	Gate	

**Applications:**

- ◆ Motor control
- ◆ Industrial and domestic lighting
- ◆ Heating
- ◆ Static switching

**Features**

- ◆ Blocking voltage to 600 V
- ◆ On-state RMS current to 12 A

SYMBOL	PARAMETER	Value	Unit
$V_{DRM}$	Repetitive peak off-state voltages	600	V
$I_T \text{ (RMS)}$	RMS on-state current (full sine wave)	12	A
$I_{TSM}$	Non-repetitive peak on-state current (full cycle, $T_j \text{ initial}=25^\circ\text{C}$ )	120	A

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
$R_{th(j-c)}$	Junction to case(AC)		-	1.3	-	°C/W
$R_{th(j-a)}$	Junction to ambient		-	60	-	°C/W



S6012R

SCRs

HAOPIN MICROELECTRONICS CO.,LTD.

Limiting values in accordance with the Maximum system(IEC 134)

SYMBOL	PARAMETER	CONDITIONS			MIN	Value	UNIT
$V_{DRM}$	Repetitive peak off-state Voltages				-	600	V
$I_{T(RMS)}$	RMS on-state current				-	12	A
$I_{TSM}$	Non repetitive surge peak on-state current	$F=50Hz$			-	100	A
					$F=60Hz$	120	A
$I^2t$	$I^2t$ for fusing	$T_p=10ms$			-	60	$A^2s$
DI/dt	Critical rate of rise of on-state current	$IG=2x I_{GT}, tr \leq 100ns$	$F=120Hz$	$T_c=125^\circ C$	-	100	$A/\mu s$
$I_{GM}$	Peak gate current				-	2	A
$I_{DRM} I_{RRM}$	$V_{DRM}=V_{RRM}$	$T_c=25^\circ C$ $T_c=100^\circ C$ $T_c=125^\circ C$			-	0.01 0.5 1	mA
$P_{G(AV)}$	Average gate power				-	0.5	W
$P_{GM}$					-	20	W

 $T_j=25^\circ C$  unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
Static characteristics						
$I_{GT}$			1	-	20	mA
$V_{GT}$		$T_c=25^\circ C$	-	-	1.5	V
$I_H$			-	-	40	mA
$V_{TM}$		$T_c=25^\circ C$	-	-	1.6	V
dV/dt		$T_c=100^\circ C$	300 225	-	-	$V/\mu s$

## Dynamic Characteristics

Tgt			-	2	-	$\mu s$
tq			-	-	35	$\mu s$

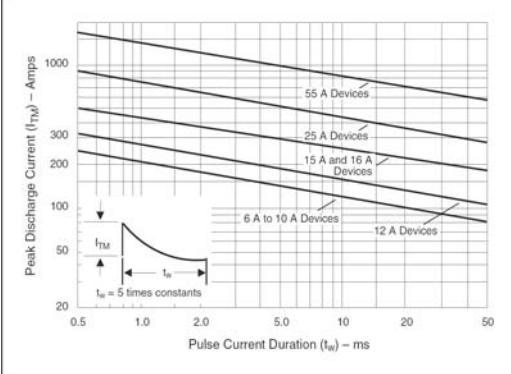
**HAOPIN MICROELECTRONICS CO., LTD.**
**Description**


Figure E6.1 Peak Capacitor Discharge Current (6A through 55A)

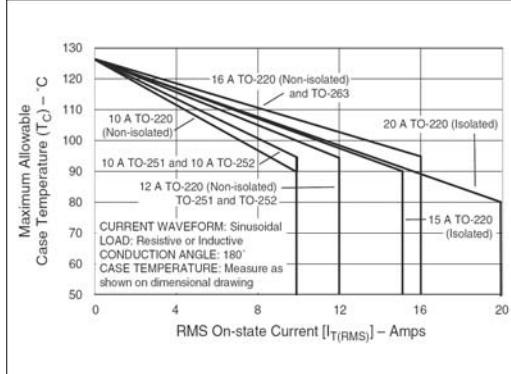


Figure E6.2 Maximum Allowable Case Temperature versus RMS on-state current

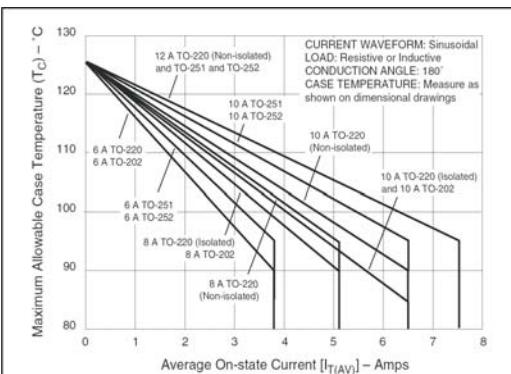


Figure E6.3 Maximum Allowable Case Temperature Versus Average On-state Current

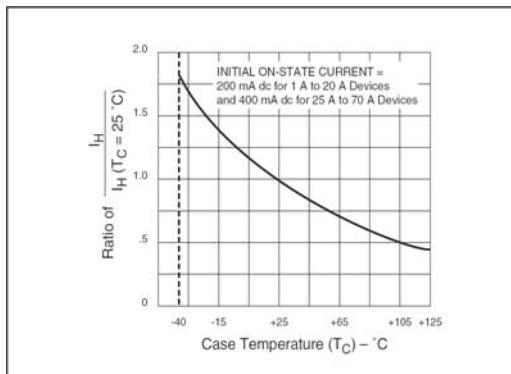


Figure E6.4 Normalized dc Holding Current versus Case Temperature

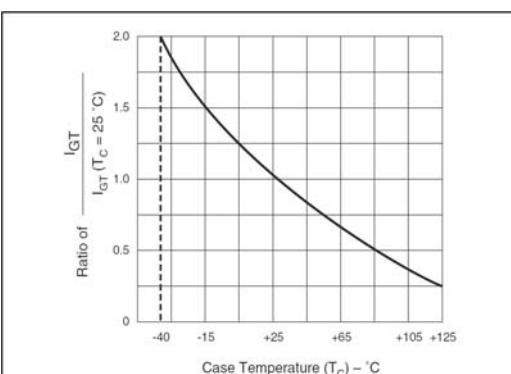


Figure E6.5 Normalized DC Gate-Trigger Current versus Case Temperature

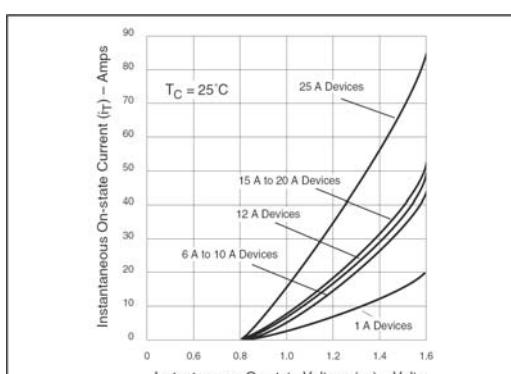


Figure E6.6 Instantaneous On-state Current versus On-state Voltage(typical)

## HAOPIN MICROELECTRONICS CO.,LTD.

## Description

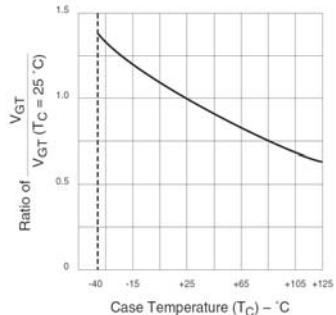


Figure E6.7 Normalized DC Gate-trigger Voltage versus Case Temperature

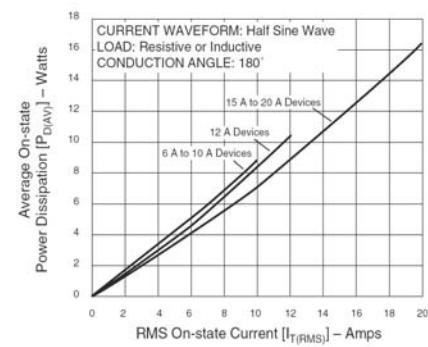
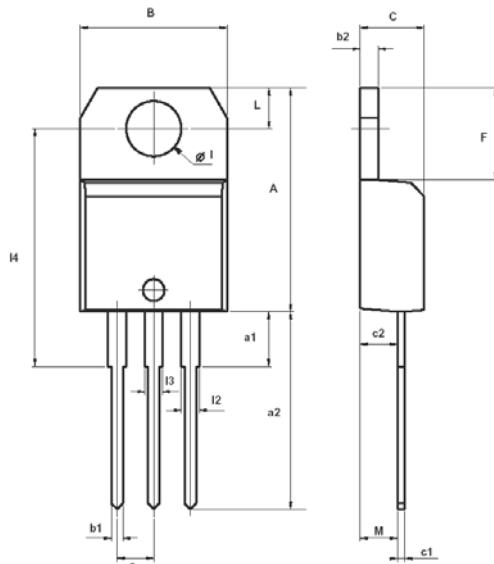


Figure E6.8 Power Dissipation (Typical)versus RMS Pn-state Current (6Athrough 20A)

**HAOPIN MICROELECTRONICS CO.,LTD.**
**MECHANICAL DATA**

Dimensions in mm  
 Net Mass: 2 g  
 TO-220



REF.	DIMENSIONS					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	15.20		15.90	0.598		0.625
a1		3.75			0.147	
a2	13.00		14.00	0.511		0.551
B	10.00		10.40	0.393		0.409
b1	0.61		0.88	0.024		0.034
b2	1.23		1.32	0.048		0.051
C	4.40		4.60	0.173		0.181
c1	0.49		0.70	0.019		0.027
c2	2.40		2.72	0.094		0.107
e	2.40		2.70	0.094		0.106
F	6.20		6.60	0.244		0.259
I	3.75		3.85	0.147		0.151
I4	15.80	16.40	16.80	0.622	0.646	0.661
L	2.65		2.95	0.104		0.116
I2	1.14		1.70	0.044		0.066
I3	1.14		1.70	0.044		0.066
M		2.60			0.102	